# **Amplifier Transistors**

### **PNP Silicon**

### **Features**

• These are Pb-Free Devices\*



Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	-50	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	-60	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	-5.0	Vdc
Collector Current - Continuous	Ic	-100	mAde
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	PD	350 2.8	mW mW/°C
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	PD	1.0 8.0	W mW/°C
Operating and Storage Junction Temperature Range	TJ, Tstg	-55 to +150	°C

### THERMAL CHARACTERISTICS

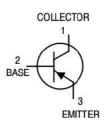
Characteristic	Symbol	Max	Unit °C/W	
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub>	357		
Thermal Resistance, Junction-to-Case	R <sub>0JC</sub>	125	°C/W	

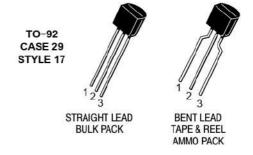
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



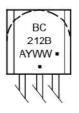
### ON Semiconductor®

http://onsemi.com





### MARKING DIAGRAM



= Assembly Location

= Year WW = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
BC212BG	TO-92 (Pb-Free)	5000 Units / Bulk
BC212BRL1G	TO-92 (Pb-Free)	2000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Collector - Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	-50	-	-	Vdc
Collector - Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-60	-	-	Vdc
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	-5	- T	-	Vdc
Collector-Emitter Leakage Current	СВО	072		-15	nAdc
Emitter-Base Leakage Current	<sub>EBO</sub>	823	-	-15	nAdc
ON CHARACTERISTICS		-			
DC Current Gain (I <sub>C</sub> = -10 μAdc, V <sub>CE</sub> = -5.0 Vdc)	h <sub>FE</sub>	40	<u>(70-8)</u>	-	:-
$(I_C = -2.0 \text{ mAdc}, V_{CE} = -5.0 \text{ Vdc})$		60	_	_	
(I <sub>C</sub> = -100 mAdc, V <sub>CE</sub> = -5.0 Vdc) (Note 1)		(1 <u>44</u> )	120	=	
Collector – Emitter Saturation Voltage (I <sub>C</sub> = -10 mAdc, I <sub>B</sub> = -0.5 mAdc) (I <sub>C</sub> = -100 mAdc, I <sub>B</sub> = -5.0 mAdc) (Note 1)	V <sub>CE(sat)</sub>	0.50 0.50	-0.10 -0.25	_ -0.6	Vdc
Base-Emitter Saturation Voltage (I <sub>C</sub> = -100 mAdc, I <sub>B</sub> = -5.0 mAdc)	V <sub>BE(sat)</sub>	16 <del>m</del> .:	-1.0	-1.4	Vdc
Base-Emitter On Voltage (I <sub>C</sub> = -2.0 mAdc, V <sub>CE</sub> = -5.0 Vdc)	V <sub>BE(OII)</sub>	-0.6	-0.62	-0.72	Vdc
DYNAMIC CHARACTERISTICS			-		
Current – Gain – Bandwidth Product (I <sub>C</sub> = -10 mAdc, V <sub>CE</sub> = -5.0 Vdc, f = 100 mHz)	f <sub>T</sub>	9 <u>182</u>	280	-	MHz
Common–Base Output Capacitance (V <sub>CB</sub> = -10 Vdc, I <sub>C</sub> = 0, f = 1.0 mHz)	C <sub>ob</sub>	0 <del>.5</del> 3	<del>17</del> 8	6.0	pF
Noise Figure (I <sub>C</sub> = $-0.2$ mAdc, V <sub>CE</sub> = $-5.0$ Vdc, R <sub>S</sub> = $2.0$ k $\Omega$ , f = $1.0$ kHz, f = $200$ Hz)	NF	88 <del>100</del> .0	=	10	dB
Small-Signal Current Gain (I <sub>C</sub> = -2.0 mAdc, V <sub>CE</sub> = -5.0 Vdc, f = 1.0 kHz)	h <sub>fe</sub>	200	-	400	82

<sup>1.</sup> Pulse Test: Tp 300 s, Duty Cycle 2.0%.

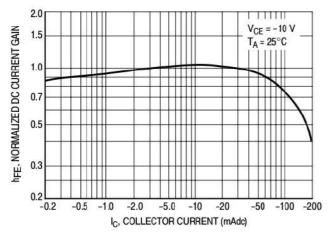


Figure 1. Normalized DC Current Gain

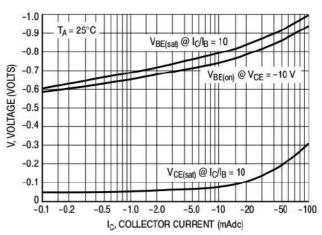


Figure 2. "Saturation" and "On" Voltages

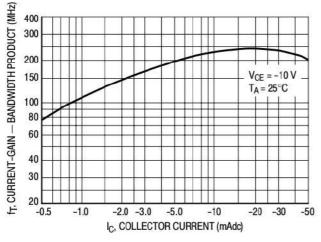


Figure 3. Current-Gain - Bandwidth Product

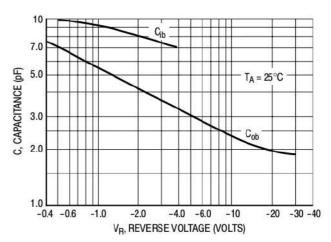


Figure 4. Capacitances

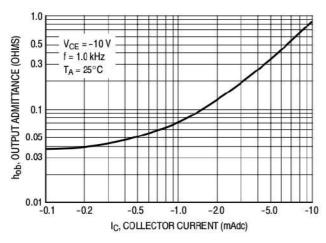


Figure 5. Output Admittance

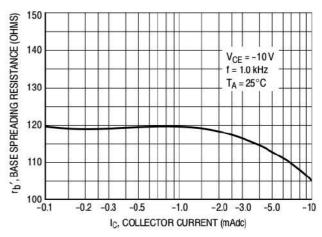
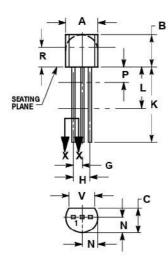


Figure 6. Base Spreading Resistance

### PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 ISSUE AM



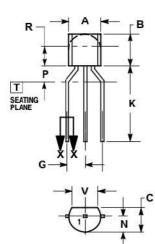
STRAIGHT LEAD **BULK PACK** 



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
   CONTROLLING DIMENSION: INCH.
- CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED. LEAD DIMENSION IS UNCONTROLLED IN P AND
- BEYOND DIMENSION K MINIMUM.

- 1	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
A	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
н	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250	) .eee.	6.35	
N	0.080	0.105	2.04	2.66
Р		0.100		2.54
R	0.115		2.93	
٧	0.135		3.43	934



BENTIFAD TAPE & REEL AMMO PACK



#### NOTES

- TES:
  DIMENSIONING AND TOLERANCING PER
  ASME Y14.5M, 1994.
  CONTROLLING DIMENSION: MILLIMETERS.
  CONTOUR OF PACKAGE BEYOND
  DIMENSION R IS UNCONTROLLED.

- LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	MILLIMETERS		
DIM	MIN	MAX	
A	4.45	5.20	
В	4.32	5.33	
C	3.18	4.19	
D	0.40	0.54	
G	2.40	2.80	
J	0.39	0.50	
K	12.70		
N	2.04	2.66	
P	1.50	4.00	
R	2.93		
٧	3.43		

STYLE 17:

COLLECTOR PIN 1.

2. BASE

EMITTER

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make charges without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees airsing out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

### PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

LITERALURE FULFILLMENT: Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free

Europe, Middle East and Africa Technical Support: Pnone: 421 33 790 2910 Japan Customer Focus Center

Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative